

## **Devices and Basic Circuits [Diode Circuits]**

# Overview

- **Introduction**
- **What are P-type and N-type semiconductors??**
- **What are Diodes?**
- **Forward Bias & Reverse Bias**
- **Characteristics Of Ideal Diode**
- **Shockley Equation**
- **I – V Characteristics of Diodes**

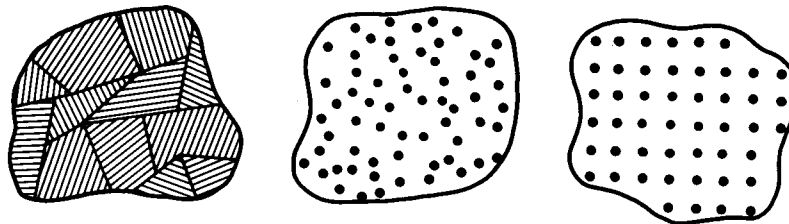
# Introduction

Semiconductors are materials whose electrical properties lie between Conductors and Insulators.

Ex : Silicon and Germanium

## What is a Semiconductor ?

- $V=IR$  , If we measure the current  $I$  flowing through a bar of a homogenous material with uniform cross section, when a voltage  $V$  is applied across it.  $R=V/I$
- Resistivity is a basic property of the material is related to the resistance of bar by a geometric ratio:  $\rho=RA/L$
- Low resistivity => “conductor”  $10^{-6} \Omega \text{ cm}$  (Al, Cu...)
- High resistivity => “insulator” non-crystalline  $10^{16} - 10^{18} \Omega \text{ cm}$   $\text{SiO}_2$ ....)
- Intermediate resistivity => “semiconductor”
  - conductivity lies between that of conductors and insulators
  - generally crystalline in structure for IC devices
    - In recent years, however, semiconductors have become commercially very important



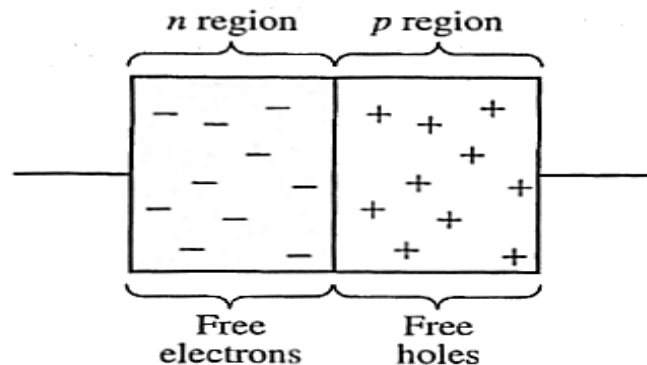
polycrystalline   amorphous   crystalline

## What are P-type and N-type ?

- Semiconductors are classified into P-type and N-type semiconductor
- P-type: A P-type material is one in which holes are majority carriers i.e. they are positively charged materials (++++)
- N-type: A N-type material is one in which electrons are majority charge carriers i.e. they are negatively charged materials (-----)

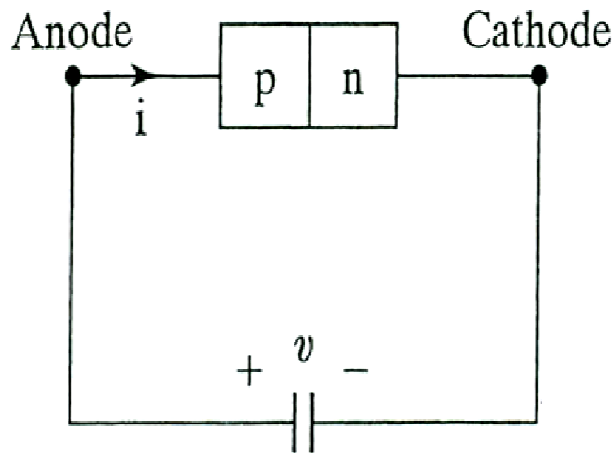
### Diodes:

Electronic devices created by bringing together a *p*-type and *n*-type region within the same semiconductor lattice. Used for rectifiers, LED etc

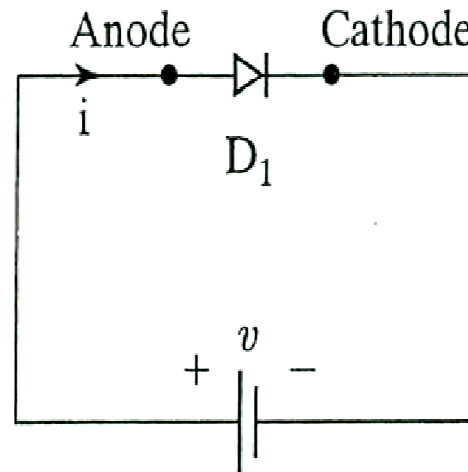


## DIODE CIRCUITS AND THEIR APPLICATIONS

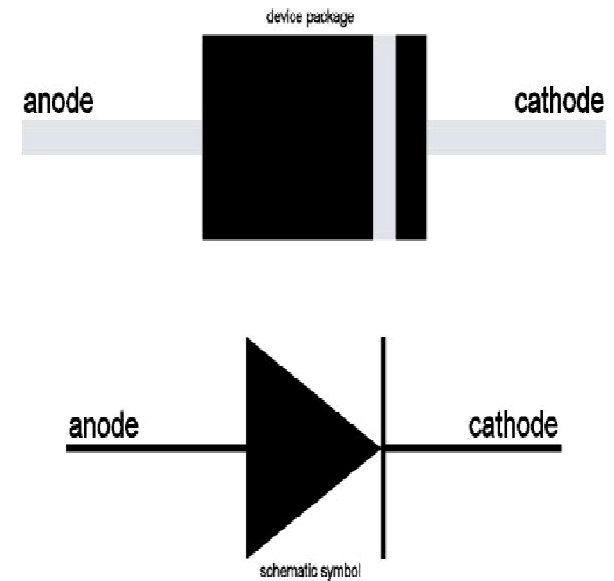
- A diode is a two-terminal pn-junction device.
- A diode can be considered to be an electrical one-way valve.
- They are made from a large variety of materials including silicon, germanium, gallium arsenide, silicon carbide ...



(a) pn-junction



(b) Diode symbol



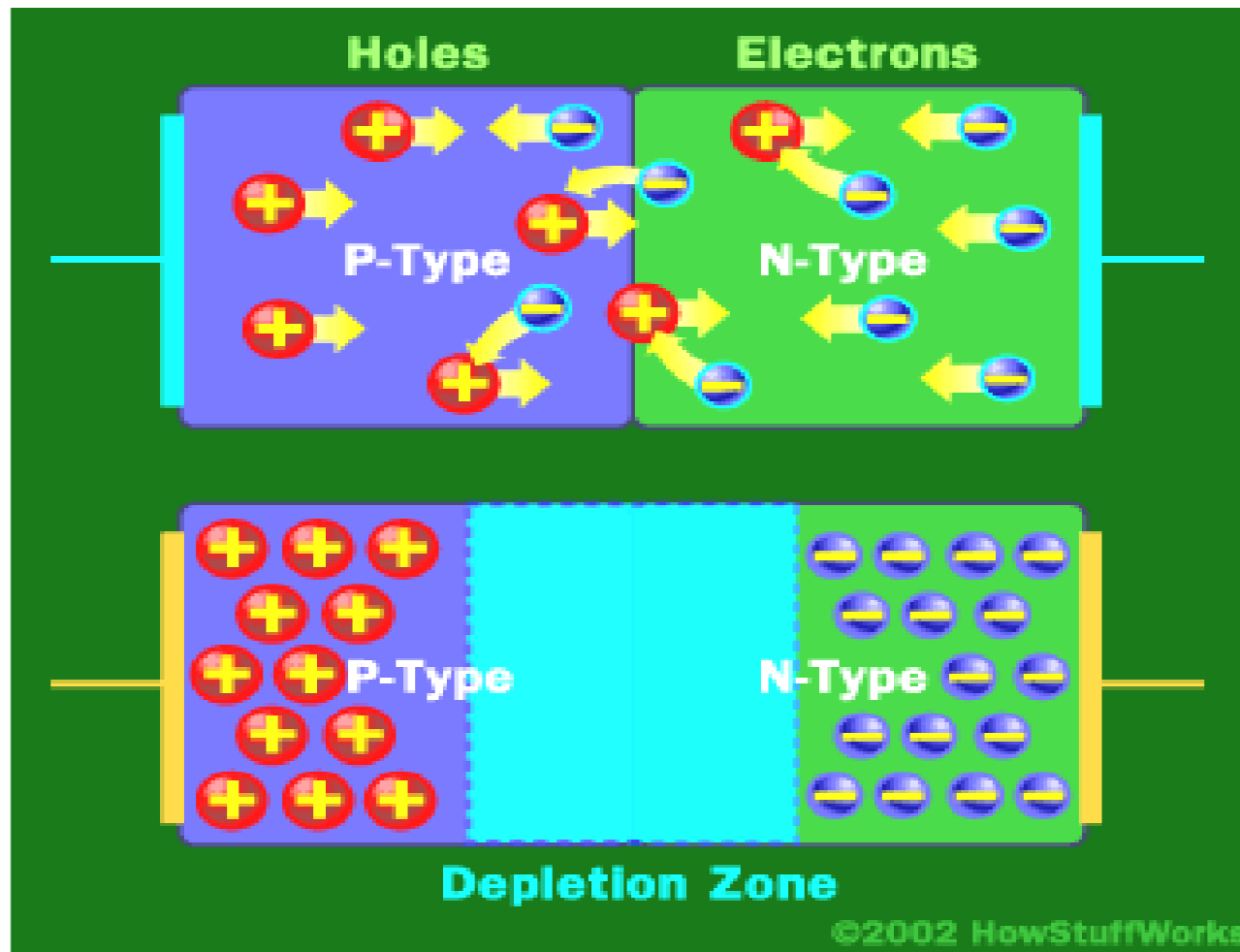
Forward biased



Reverse biased



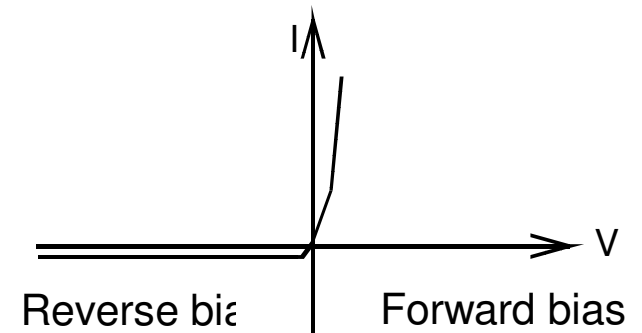
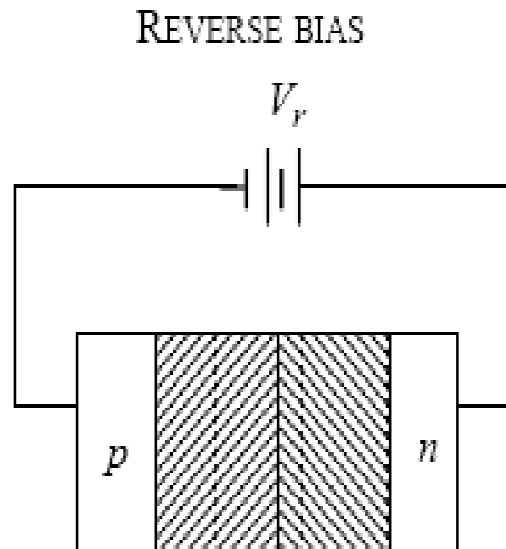
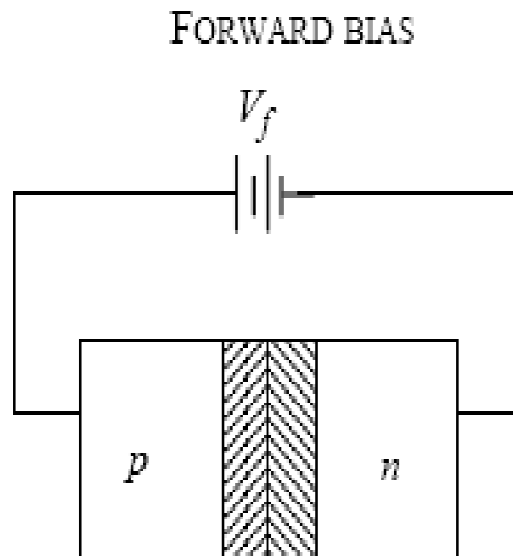
## How Diodes Work



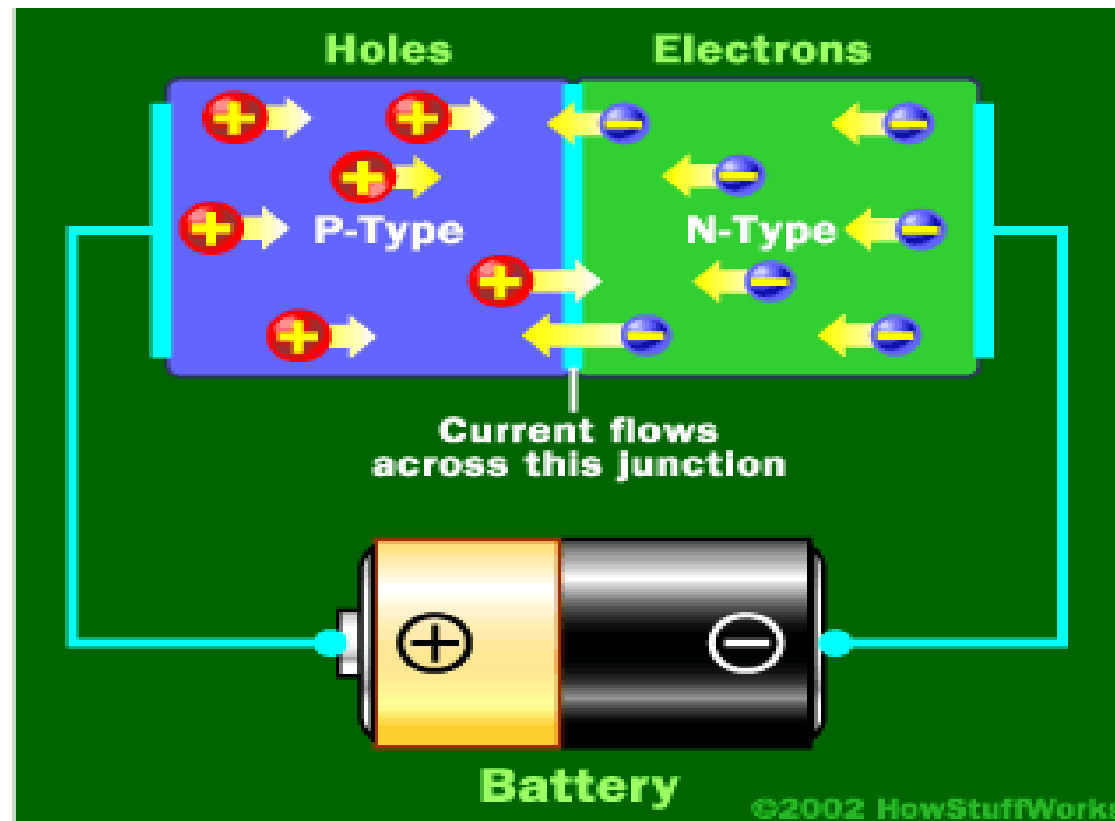
At the junction, free electrons from the N-type material fill holes from the P-type material. This creates an insulating layer in the middle of the diode called the depletion zone.

## Forward Bias and Reverse Bias

- Forward Bias : Connect positive of the Diode to positive of supply...negative of Diode to negative of supply
- Reverse Bias: Connect positive of the Diode to negative of supply...negative of diode to positive of supply.



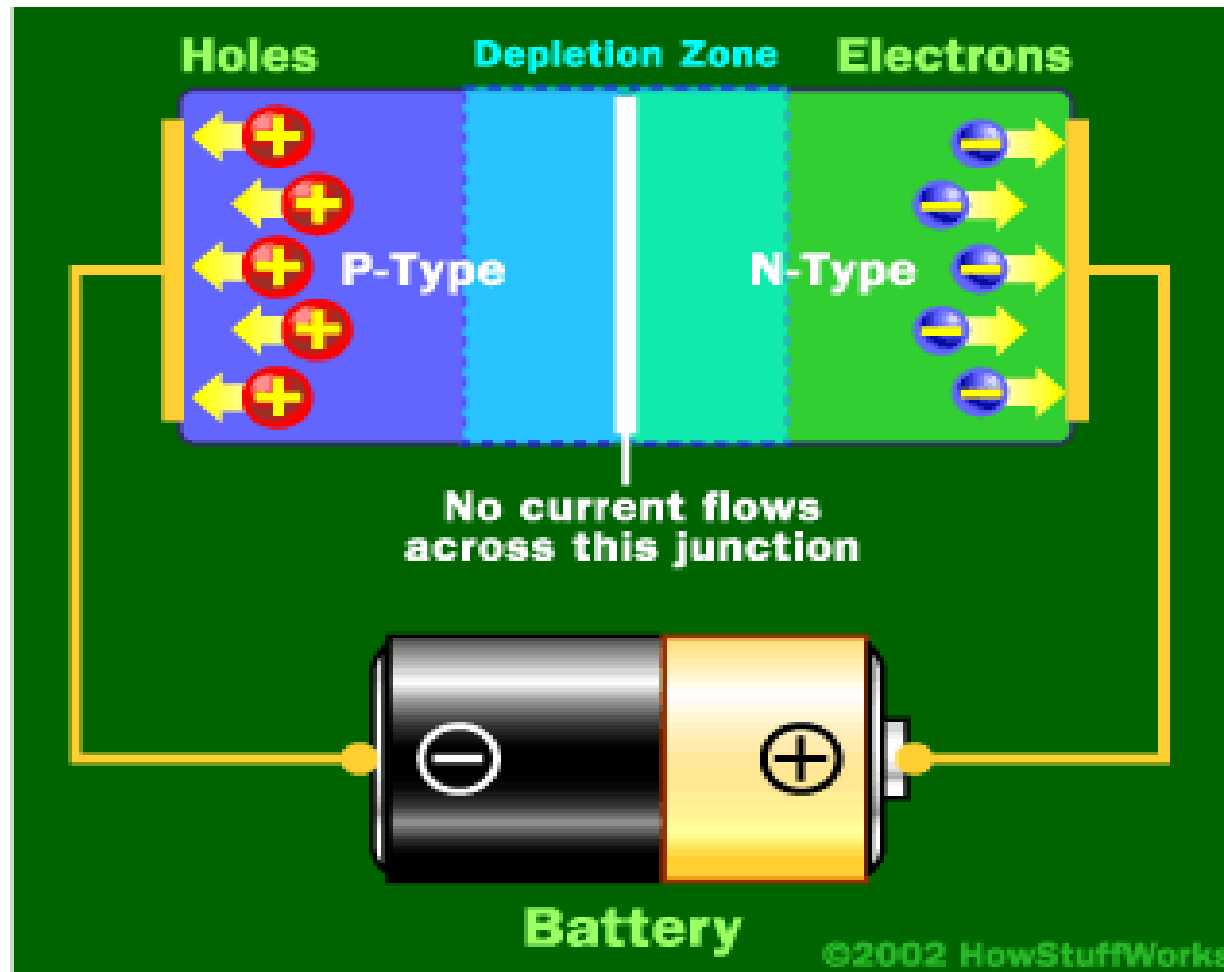
## Forward-Biased P-N Junctions



When the negative end of the circuit is hooked up to the N-type layer and the positive end is hooked up to P-type layer, electrons and holes start moving and the depletion zone disappears.

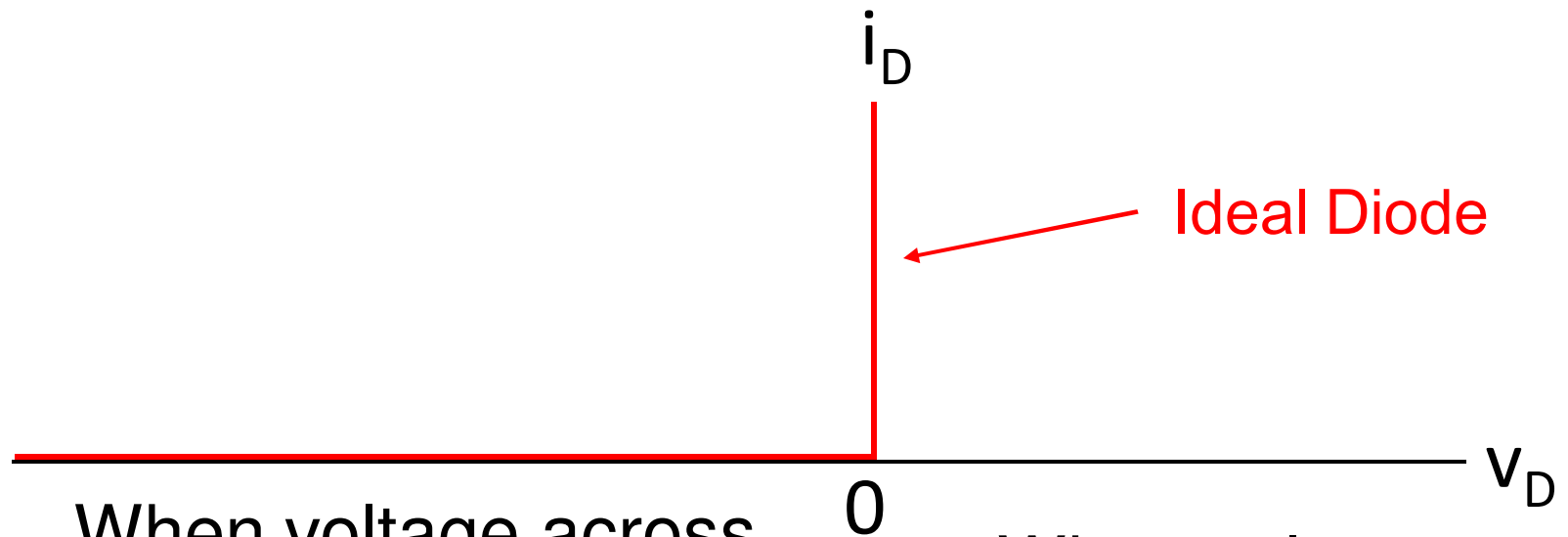


## Reversed-Biased P-N Junctions



When the positive end of the battery is hooked up to the N-type layer and the negative end is hooked up to the P-type layer, free electrons collect on one end of the diode and holes collect on the other. The depletion zone gets bigger and no current flows.

## I-V characteristic for an ideal diode

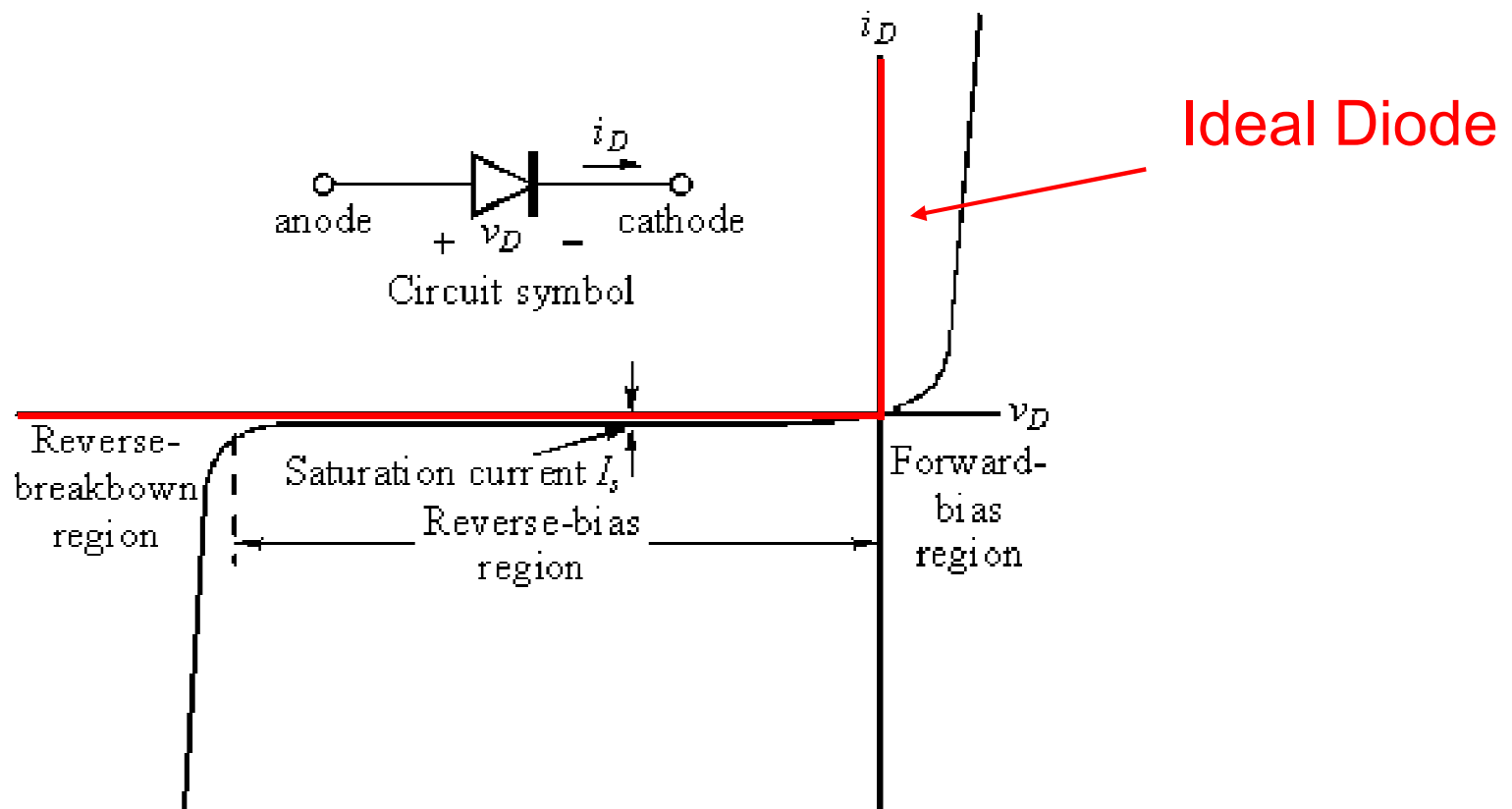


When voltage across the diode is negative, the diode looks like an open circuit.

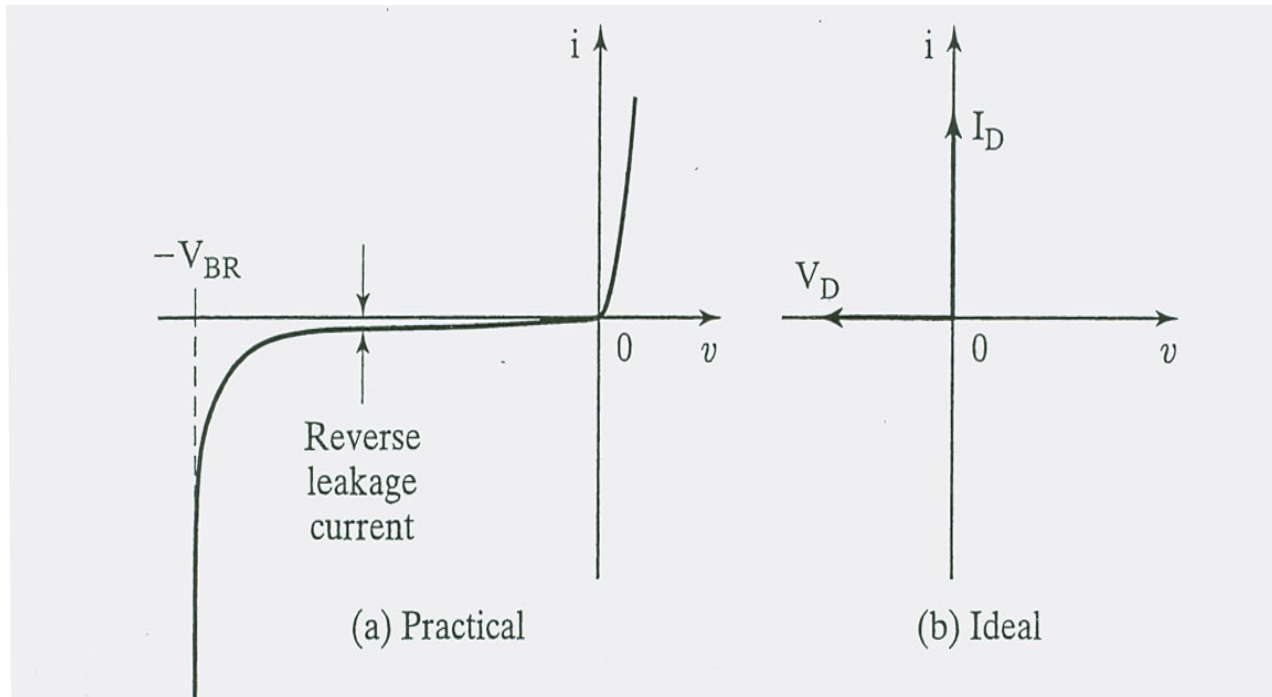
When voltage across the diode is positive, the diode looks like a short.

The I-V characteristics of a diode is shown below:

- Real diode is close to ideal



**The I-V characteristics of a diode is shown below:**



➤ This characteristic can be expressed by an equation known as Shockley diode equation:

$$I_D = I_s (e^{V_D / nV_T} - 1)$$

$I_D$  = Majority charge carriers Current

$I_s$  = Minority charge carriers Current

➤  $V_T$  is a constant called thermal voltage and is given by:

$$V_T = \frac{kT}{q}$$

$$V_T \cong 26 \text{ mV}$$

$I_s$  is the saturation current  $\sim 10^{-14}$

$V_D$  is the diode voltage

$n$  – emission coefficient (varies from 1 - 2 )

$k = 1.38 \times 10^{-23} \text{ J/K}$  is Boltzmann's constant

$q = 1.60 \times 10^{-19} \text{ C}$  is the electrical charge of an electron.

At a temperature of 300 K,

- The diode characteristic of the figure can be divided into three regions:
  - Forward-biased region:  $V_D > 0$
  - Reverse-biased region:  $V_D < 0$
  - Breakdown region:  $V_D < -V_{BR}$

### Forward-Biased Region

$$I_D = I_s (e^{V_D / nV_T} - 1) = I_s e^{V_D / nV_T}$$

$$\text{when } v_D \geq \approx 0.1\text{V}, i_D \cong I_s \exp\left(\frac{v_D}{nV_T}\right)$$

### Reverse-Biased Region

$$I_D = I_s (e^{-|V_D| / nV_T} - 1) = -I_s$$

## Band diagram and carrier flow under bias

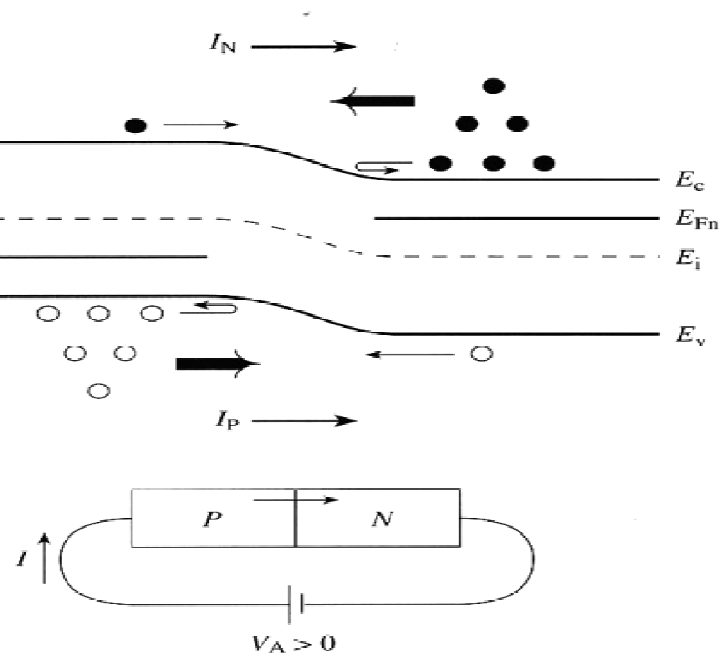
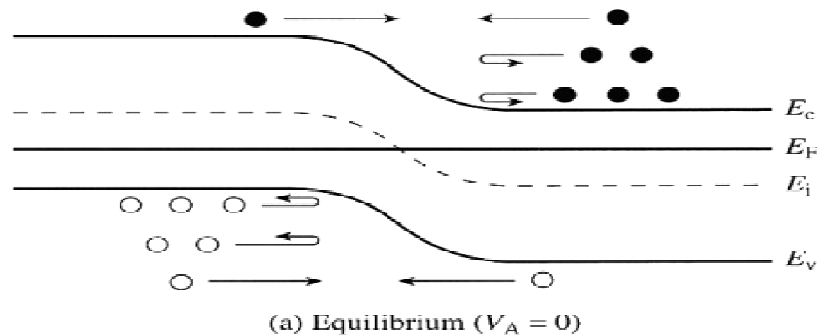


Fig. 6.1(Pierret, 1996)

- When the diode forward-bias-voltage is increased, **the barrier for electron and hole diffusion current decreases linearly**. See the band diagram.
- Since the **carrier concentration decreases exponentially with energy** in both bands, diffusion current increases **exponentially as the barrier is reduced**.
- As the reverse-bias-voltage is increased, **the diffusion current decreases rapidly to zero**, since the fall-off in current is exponential.

## Band diagram and carrier flow under bias

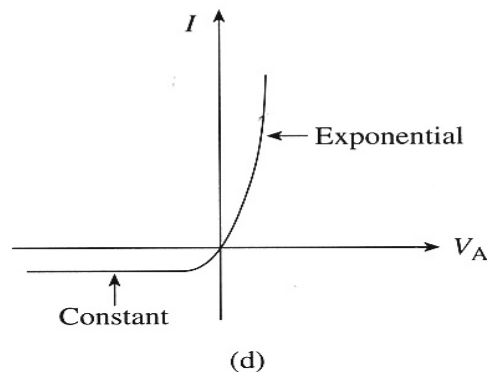
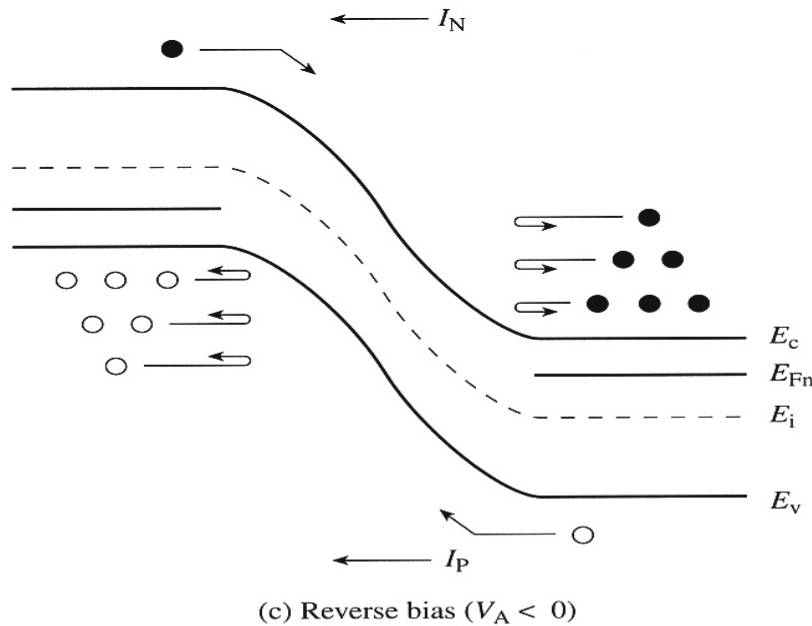


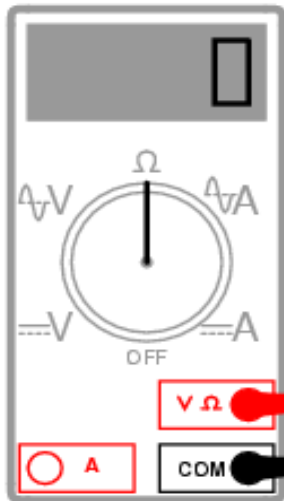
Figure 6.1 Continued.

When the reverse-bias-voltage is increased, **the net electric field increases, but drift current *does not* change.** In this case, drift current is limited **NOT** by **HOW FAST** carriers are swept across the depletion layer, but rather **HOW OFTEN**.

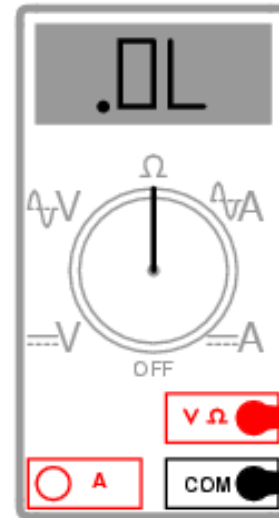
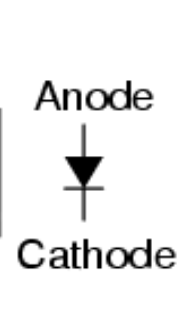
The number of carriers drifting across the depletion layer is **small** because the **number of minority carriers that diffuse towards the edge of the depletion layer is small.**

To a first approximation, the drift current **does not change** with the **applied voltage.**

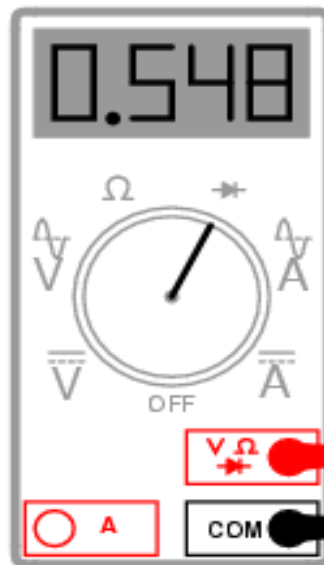
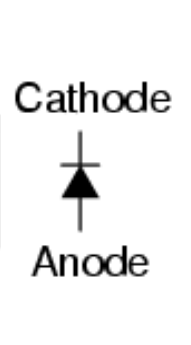
## Diode – Characteristic



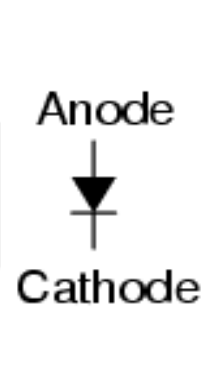
*Diode is forward-biased by ohmmeter -- shows 0 ohms of resistance.*



*Diode is reverse-biased by ohmmeter -- shows infinite resistance.*

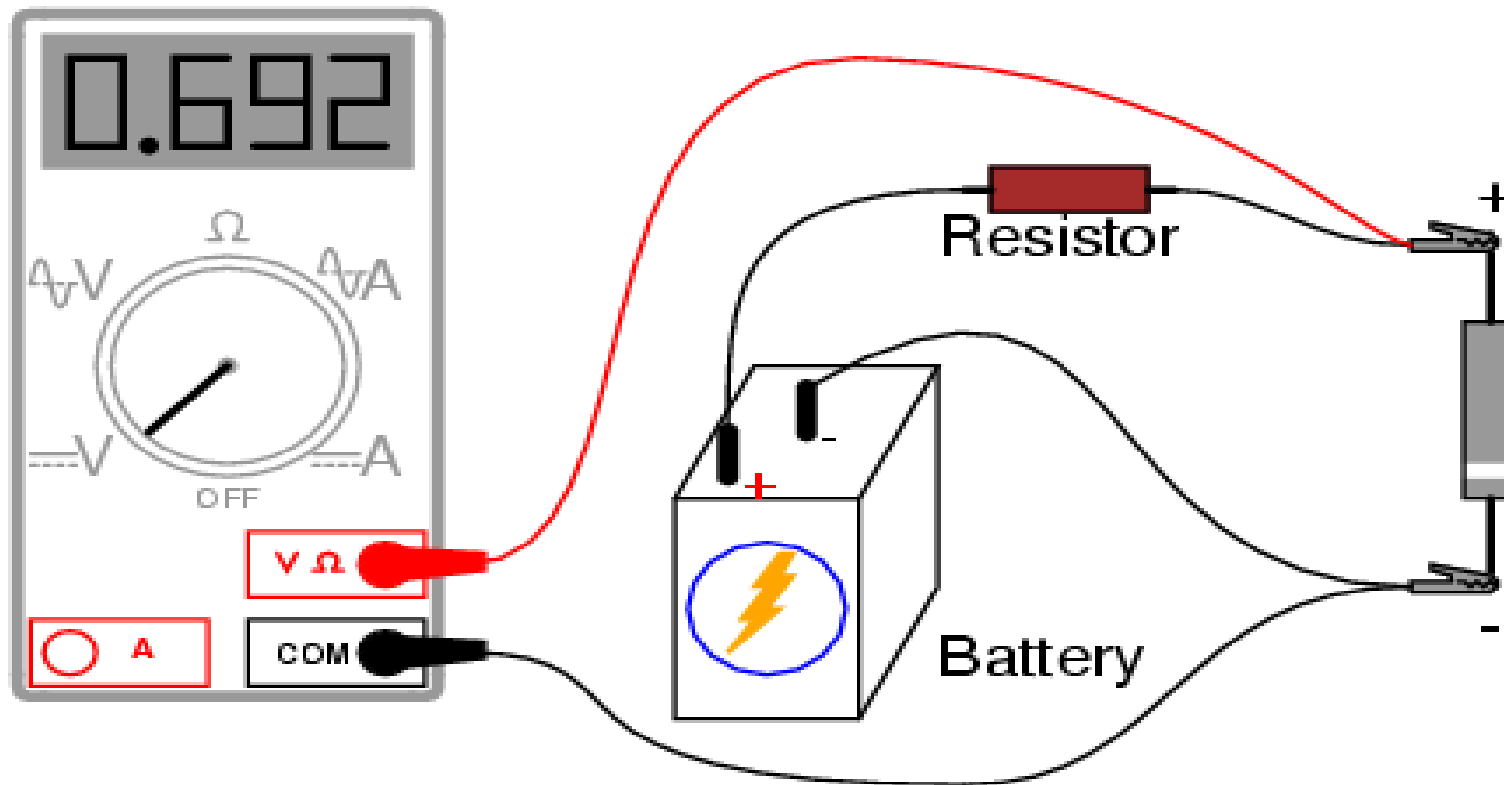


*Diode is forward-biased by meter -- shows a forward voltage drop of 0.548 volts.*

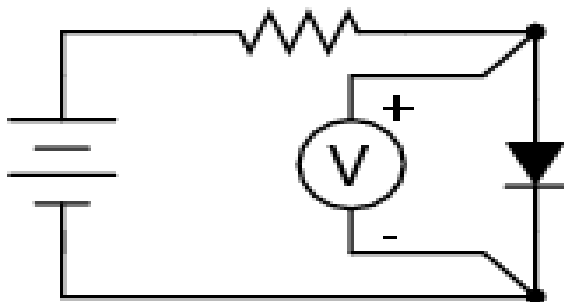




## Diode – Characteristic :



*Schematic diagram*



Resistor sized to obtain diode current of desired magnitude.

## Diodes – Load-Line Analysis of Diode Circuits

### Load-Line Analysis of Diode Circuit

We can use  $v = iR$ ,  $i = C \frac{dv}{dt}$ ,  $v = L \frac{di}{dt}$ , ...

but when there is a diode :  $i_D = I_s \left[ \exp\left(\frac{v_D}{nV_T}\right) - 1 \right]$

It is difficult to write KCL or KVL equations.

For the circuit shown,

KVL gives :

$$V_{SS} = Ri_D + v_D$$

If the  $I - V$  curve of the diode is given,

we can perform the

"Load - Line Analysis"

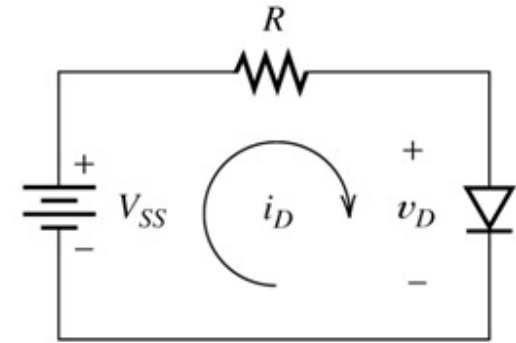


Figure Circuit for load-line analysis.

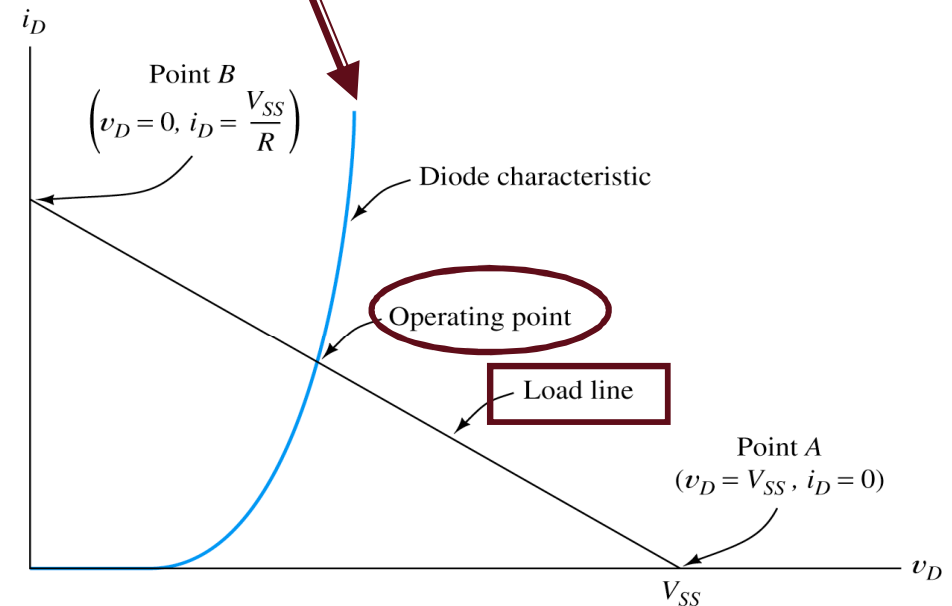
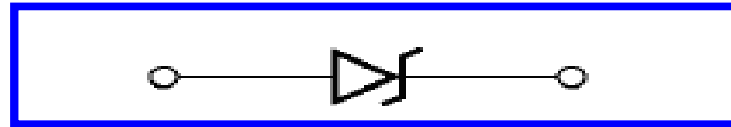
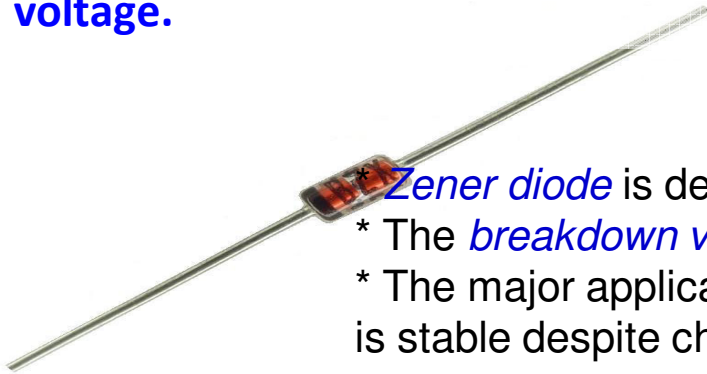


Figure 10.6 Load-line analysis of the circuit of Figure 10.5.

# Zener diode

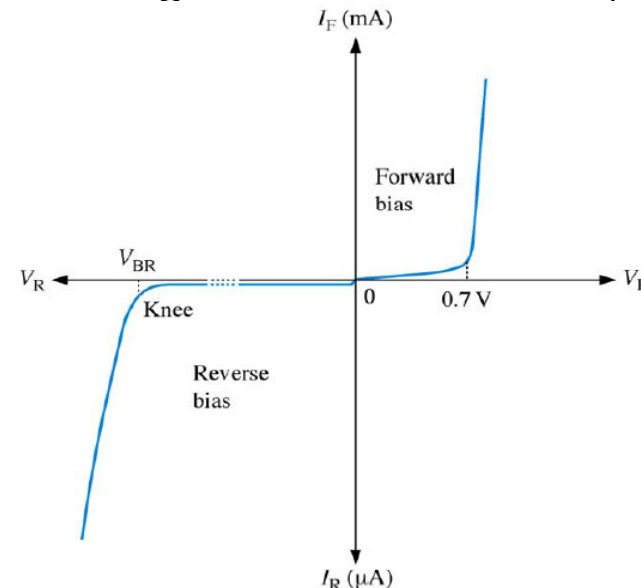
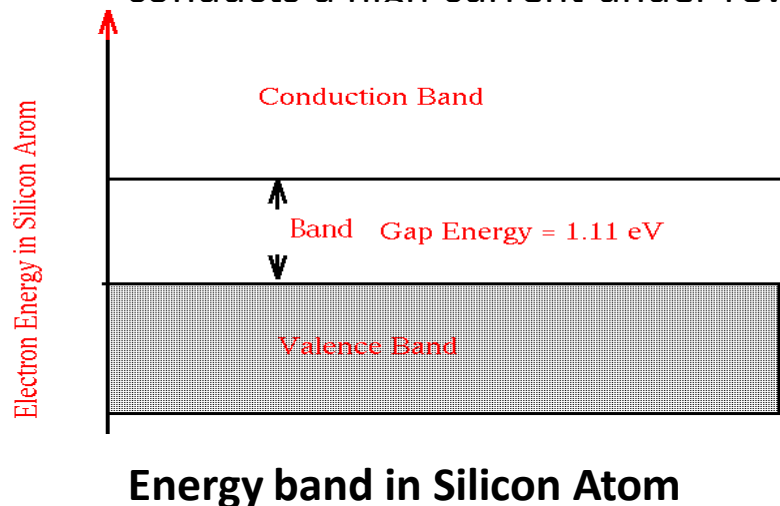
A zener diode is a p-n junction device which is designed for a specific *reverse breakdown* voltage.



- \* *Zener diode* is designed for operation in the reverse-breakdown region.
- \* The *breakdown voltage* is controlled by the doping level ( $-1.8\text{ V}$  to  $-200\text{ V}$ ).
- \* The major application of Zener diode is to provide an output reference that is stable despite changes in input voltage – power supplies, voltmeter,...

## Zener effect:

High reverse voltages can provide electrons enough energy to “jump” from valence band to conduction band, thus creating free electrons. Hence, the diode conducts a high current under reverse



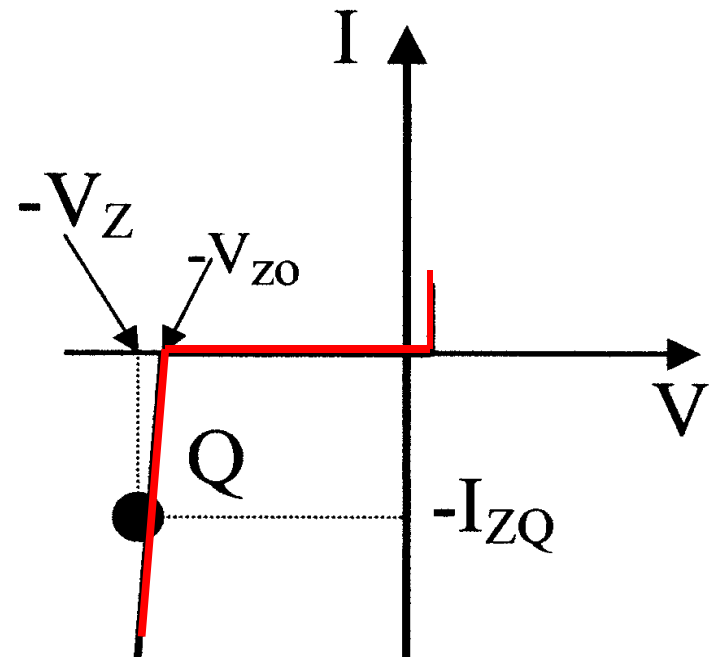
## Zener Diode

- The slope of the line at Q is  $1/r_z$
- $r_z$  is called the incremental resistance of the zener diode
- This is exaggerated for clarity in the figure. In practice  $r_z$  is small (a few ohms) and the breakdown voltage is approximately constant irrespective of the reverse current.

• **Zener breakdown** occurs when the electric field in the depletion layer increases to the point where it can break covalent bonds and generate electron-hole pairs.

• Electrons generated in this way are swept by the electric field into the n side.

• Holes generated in this way are swept by the electric field into the p side.

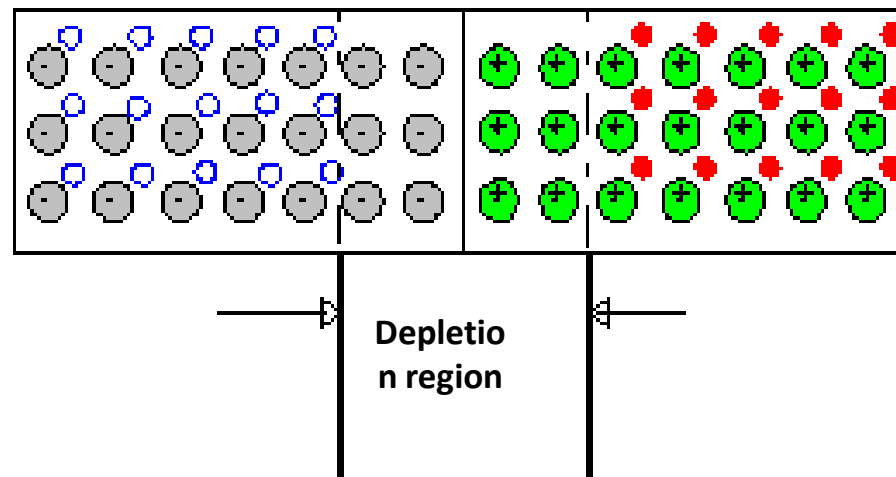


- These electrons and holes constitute a reverse current through the junction.
- Once the zener effect starts a large number of carriers can be generated with negligible increase in the junction voltage.
- In the breakdown region the reverse current is thus determined by the external circuit, the reverse voltage across the diode remains close to the rated breakdown voltage.
- The other breakdown mechanism is **avalanche breakdown**.
- This occurs when minority carrier in the depletion layer gain sufficient kinetic energy to break covalent bonds in atoms when they collide.
- **Avalanche breakdown**.
- Carriers liberated may have or gain sufficient energy to cause other carriers to be generated.
- This process continues in the fashion of an 'avalanche'

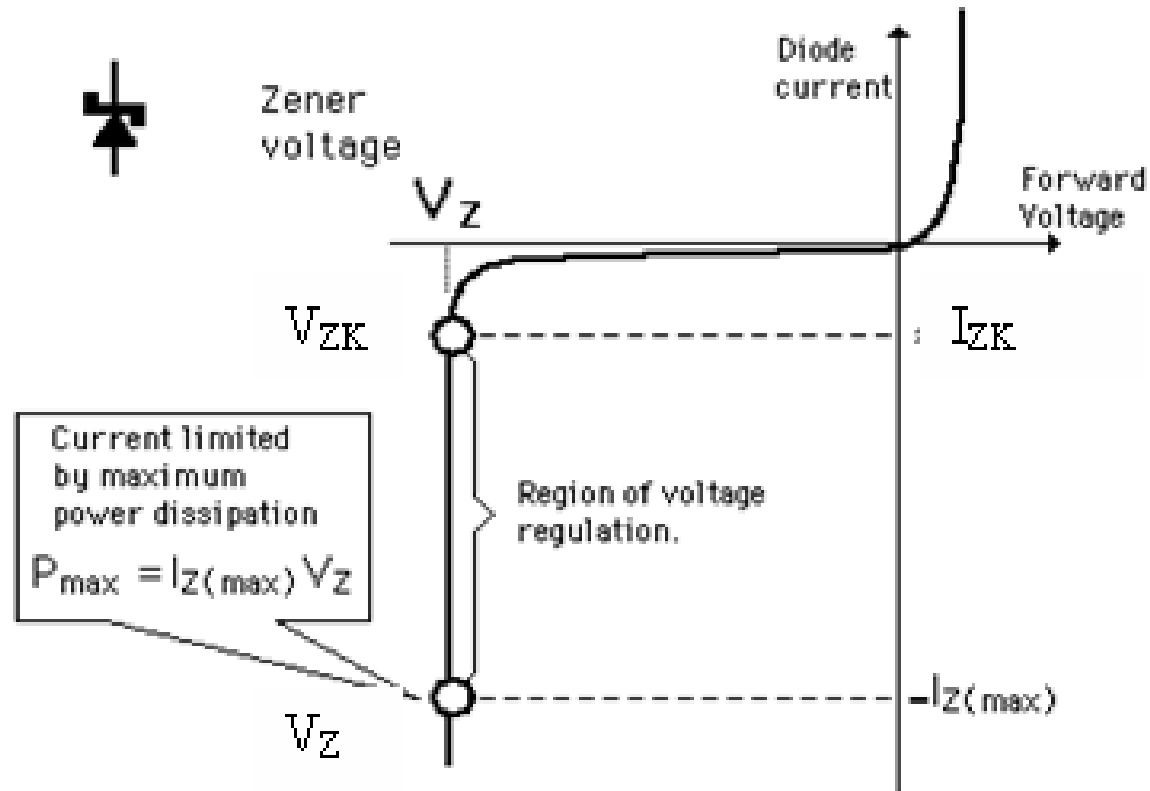
- Many carriers can be created to support any reverse current determined by the external current.
- The device is operated in reverse bias.
- Thus we reverse the sign notation that we normally use for diode voltages and currents, as shown on the next slide

## Avalanche effect:

Minority carriers in the depletion region are strongly accelerated by the electric field, thus creating electron-hole pairs by impact ionization. The increase of free carriers increases the current, which provides more carriers to create impact ionization



## I-V characteristic of zener diode



The Zener diode is used to provide a stable reference voltage in the face of a varying supply voltage.